

Title (en)

ANODE AND HIGH-SPEED PLATING DEVICE PROVIDED WITH SAME

Title (de)

ANODE UND VORRICHTUNG ZUR HOCHGESCHWINDIGKEITSPLATTIERUNG DAMIT

Title (fr)

ANODE ET DISPOSITIF DE PLAQUAGE À HAUTE VITESSE ÉQUIPÉ DE CELLE-CI

Publication

EP 3009537 A1 20160420 (EN)

Application

EP 14810217 A 20140606

Priority

- JP 2013125552 A 20130614
- JP 2014065049 W 20140606

Abstract (en)

Providing an anode capable of desirably performing plating for a long period of time. An anode (10) is cylindrical and forms a space between an article (1) to be plated and itself. A plating solution flows in the space. Positive voltage is applied to the anode. The anode (10) includes an outer cylinder (11) and an inner cylinder (12) welded to be in contact with an inner surface of the outer cylinder (11). The inner cylinder (12) is formed of a plate material (12A) made from platinum.

IPC 8 full level

C25D 17/12 (2006.01); **C25D 7/00** (2006.01); **C25D 17/00** (2006.01); **C25D 17/06** (2006.01)

CPC (source: EP US)

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C25D 17/06 (2013.01 - EP US); **C25D 17/10** (2013.01 - EP US); **C25D 17/12** (2013.01 - EP US); **C25D 21/10** (2013.01 - EP US)

Designated contracting state (EPC)

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Designated extension state (EPC)

BA ME

DOCDB simple family (publication)

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JP 2015001005 A 20150105; JP 6189655 B2 20170830; MX 2015016094 A 20160531; TW 201510292 A 20150316; TW I646225 B 20190101;
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